## ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18 Stylesheet Version v18.0

> Title of Invention

Molded Stiffener for Thin Substrates

Application Number :

10/077554

Confirmation Number: First Named Applicant: 3265 Chad Cobblev

Attorney Docket Number:

MTI-31591

Art Unit: Examiner: 2814 Hoa B Trinh

Search string:

( 6599365 or 6584897 or 6440777 ).pn

## **US Patent Documents**

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	6599365	2003-07-29	Jiang et al.	B1	118	504
	2	6584897	2003-07-01	Cobbley et al.	B2	101	127
	3	6440777	2002-08-27	Cobbley et al.	B2	438	118

## Signature

Examiner Name	Date